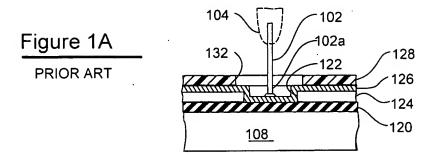
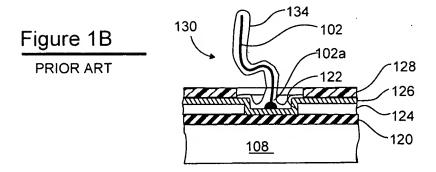
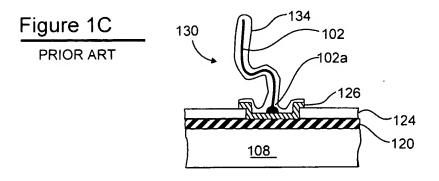
Express Mail No.: EV 321 688 892 US Ref. No.: 12221.059 / P46C1-US

Socket For Mating With Electronic Component, Particularly Semiconductor Device With Spring Packaging, For Fisturing, Testing, Burning-In Or Operating Soch A Component Pederson et al.; 1222.1059 / P46C1-US Page 1 / 15

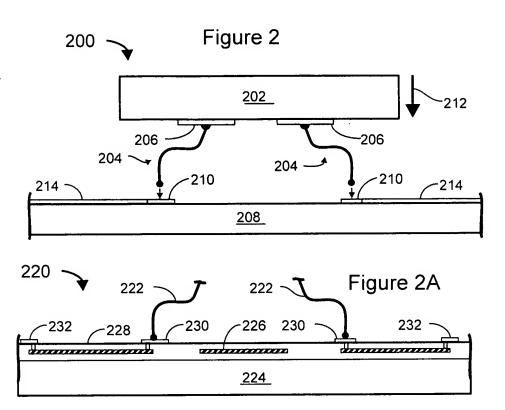
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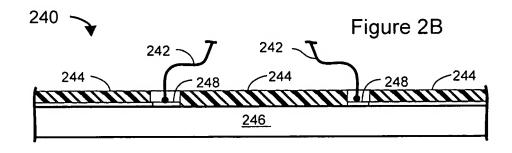


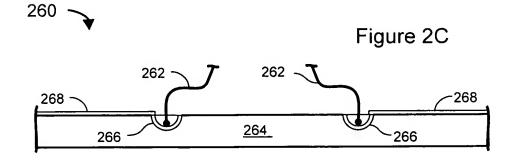


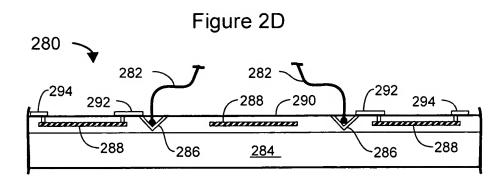


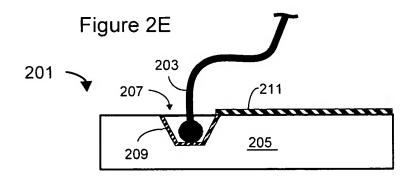
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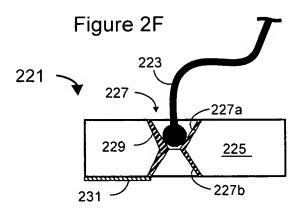


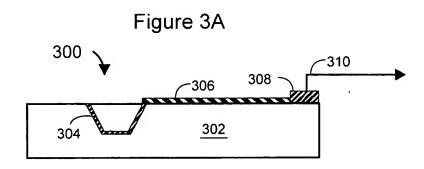


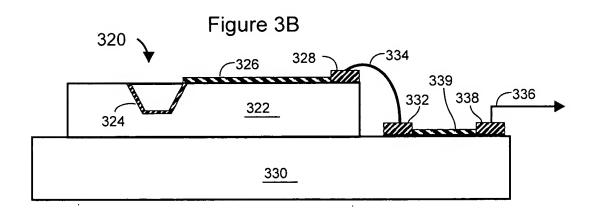


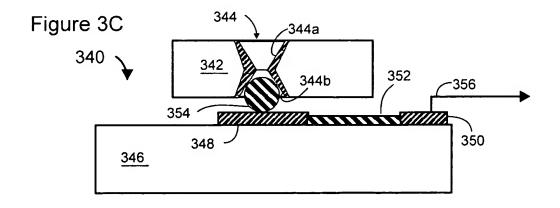


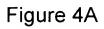












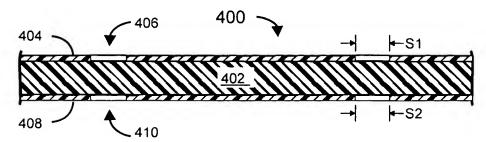


Figure 4B

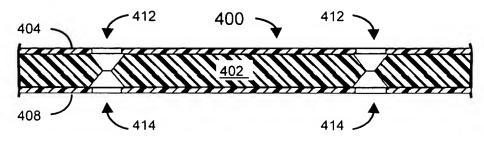


Figure 4C

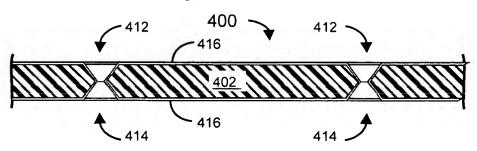


Figure 4D

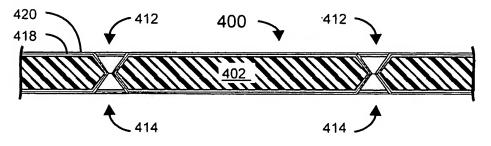


Figure 4E

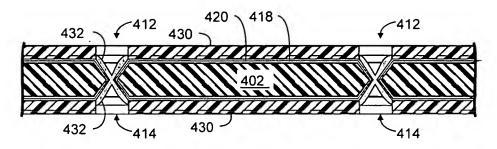


Figure 4F

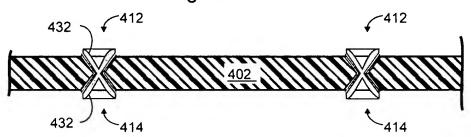


Figure 4G

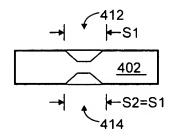


Figure 4H

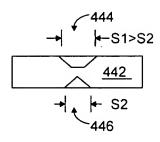


Figure 41

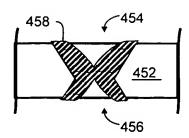


Figure 4J

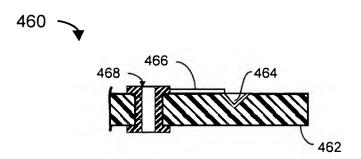
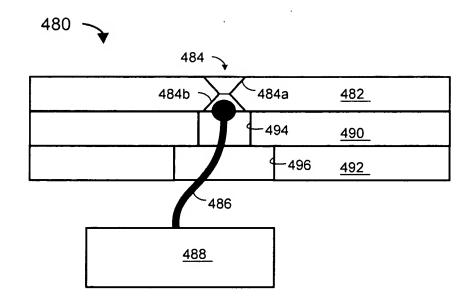
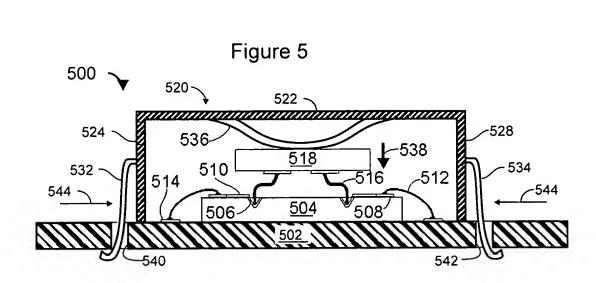
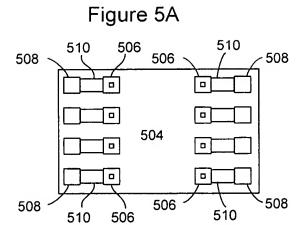


Figure 4K







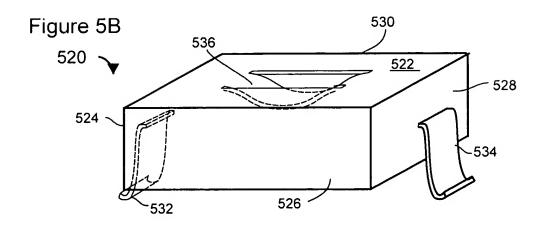


Figure 5C

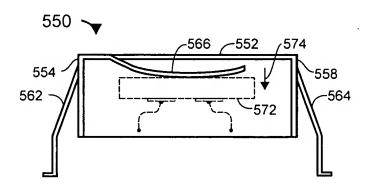
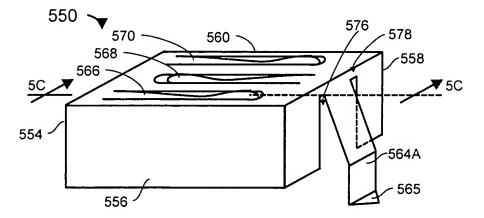


Figure 5D



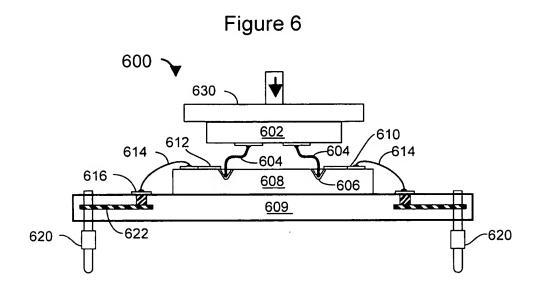


Figure 6A

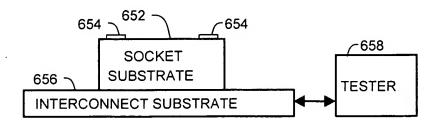


Figure 7

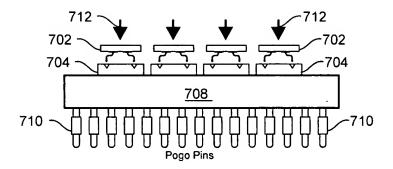
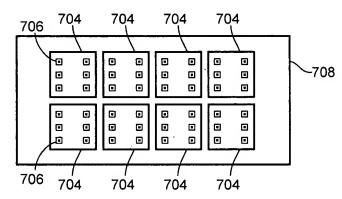
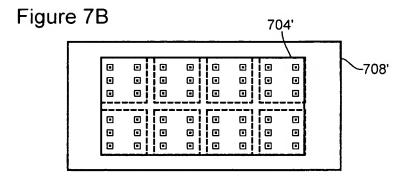
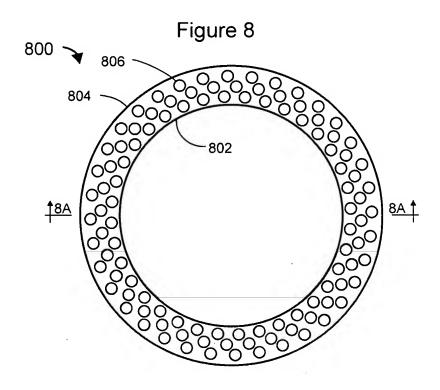
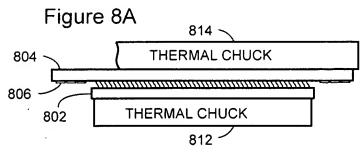


Figure 7A









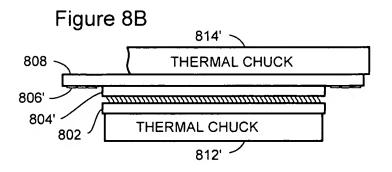


Figure 8C

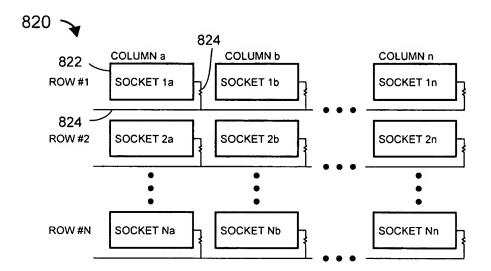


Figure 9

